

PATENT 3-9-94

W. POSS

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : KIM

Examiner: T. BILODEAU

Serial No.: 08/327,887

Group Art Unit: 1107

Filed

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Docket: 9983.3-US-01

Title

METHOD FOR FILLING CONTACT HOLES WITH METAL BY

TWO-STEP DEPOSITION

February 12, 1996

AMENDMENT UNDER 37 C.F.R. § 1.111 RECEIVED

MAR 4 1996

Hon. Assistant Commissioner for Patents Washington, D.C. 20231

GROUP 1100

Dear Sir:

In response to the Office Action mailed September 12, 1995, please amend the above-identified patent application as follows:

In the Drawings

In FIG. 2C, the depth of one of the contact holes 40 which contacts to the tungsten thin film 9 is changed in red ink.

In the Claims

Please cancel claims 3-6 without prejudice or disclaimer.

Please amend claims 1-2 and 7 as follows:

1. (Amended) A method for filling contact holes with metal

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